

ANNOUNCEMENTS

Preliminary Announcement and Call for Papers

THE SIXTH INTERNATIONAL SYMPOSIUM ON TRANSPORT PHENOMENA (ISTP-6) IN THERMAL ENGINEERING

Seoul, Korea

9-13 May 1993

The conference theme is thermal engineering in the 21st century. The symposium will provide a forum for researchers and practitioners of thermal engineering to exchange information, present new developments, and discuss the future direction and priorities in the areas of transport phenomena in thermal engineering. Previous symposia: Honolulu (Rotating Machinery, 1985); Tokyo (Turbulent Flows, 1987); Taipei (Thermal Control, 1988); Sydney (Heat and Mass Transfer, 1991); Beijing (Heat Transfer, 1992). The conference language is English. Co-sponsoring organizations are: Pacific Center of Thermal-Fluids Engineering, Korean Society of Mechanical Engineers, American Society of Mechanical Engineers, Canadian Society of Mechanical Engineers, Chinese Society of Mechanical Engineers, Flow Visualization Society of Japan, and Heat Transfer Society of Japan.

SCOPE

Papers are solicited which deal with any aspect of thermo-fluid transport phenomena (mass, momentum, heat, and energy transfer) in thermal engineering: transport phenomena in energy systems, aerospace systems, heat exchangers, environmental systems, biomedical systems, turbomachinery, electronic cooling, micro technology, materials processing, to name a few. Modeling, theory, analysis, computational methods, design, experiments, and numerical simulations are all appropriate.

SELECTION OF PAPERS

Initial screening will be based on the abstracts of approximately 500 English words. The abstract should contain: (1) paper title, (2) five keywords in the order of importance, (3) authors' names, affiliations and full addresses, and (4) name, address, phone number, and fax (teletype) number of the author to whom subsequent correspondence should be directed. The abstract should state clearly the objectives, results, and conclusions. Inclusion of one or two supporting figures or tables in the abstract that highlight the results will be particularly helpful. Final acceptance will be based on review of the complete manuscript. All accepted papers will be published in bound volumes which will be available at the meeting.

SCHEDULE

31 August 1992	Four (4) copies of abstract due
15 September 1992	Notification of abstract acceptance
15 November 1992	Five (5) copies of full-length paper due for review
15 January 1993	Notification of paper acceptance
28 February 1993	Camera-ready manuscript due

Four (4) copies of abstract should be sent by 31 August 1992 to:

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